



### N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI®

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C
201/	18.6mΩ @ V <sub>GS</sub> = 10V	8.0A
30V	26.5mΩ @ V <sub>GS</sub> = 4.5V	6.5A

### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

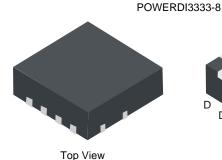
- Backlighting
- DC-DC Converters
- Power management functions

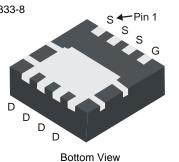
### **Features**

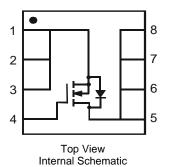
- Low R<sub>DS(ON)</sub> ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- 100% UIS (Avalanche) rated
- 100% Ra tested
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: POWERDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin annealed over Copper leadframe.
  Solderable per MIL-STD-202, Method 208 63
- Weight: 0.072 grams (approximate)







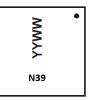
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN3029LFG-7	POWERDI3333-8	2000 / Tape & Reel
DMN3029LFG-13	POWERDI3333-8	3000 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



N39 = Product marking code YYWW = Date code marking YY = Last digit of year (ex: 10 for 2010) WW = Week code (01 – 53)



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

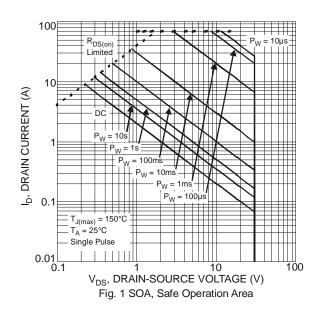
Characteri	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	30	V		
Gate-Source Voltage	V <sub>GSS</sub>	±25	V		
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	5.3 4.2	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	8.0 6.3	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	t ≤ 10s	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	9.5 7.7	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	6.5 4.9	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	t ≤ 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	7.8 6.2	А
Pulsed Drain Current (Note 7)	I <sub>DM</sub>	70	Α		
Avalanche Current (Notes 7 & 8)	I <sub>AR</sub>	18	Α		
Repetitive Avalanche Energy (Notes 7 & 8) L = 0.1mH			E <sub>AR</sub>	16	mJ

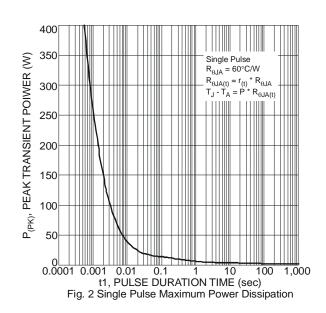
### **Thermal Characteristics**

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	1.0	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	R <sub>0JA</sub>	130.6	°C/W
Power Dissipation (Note 6)	P <sub>D</sub>	2.07	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6)	R <sub>0JA</sub>	62.5	°C/W
Power Dissipation (Note 6) t ≤ 10s	P <sub>D</sub>	3.0	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6) t ≤ 10s	R <sub>0JA</sub>	43.8	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

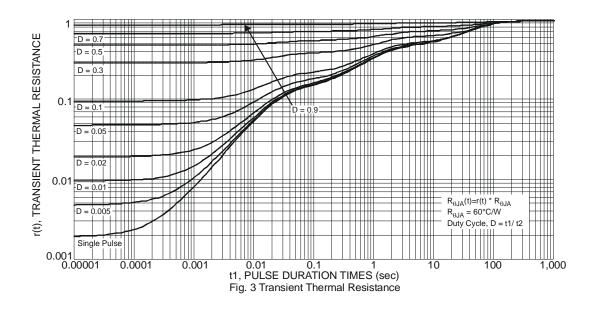
Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 6. Device mounted on 2" x 2" FR-4 PCB with high coverage 2 oz. Copper, single sided.
- 7. Repetitive rating, pulse width limited by junction temperature. 8.  $I_{AR}$  and  $E_{AR}$  rating are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .









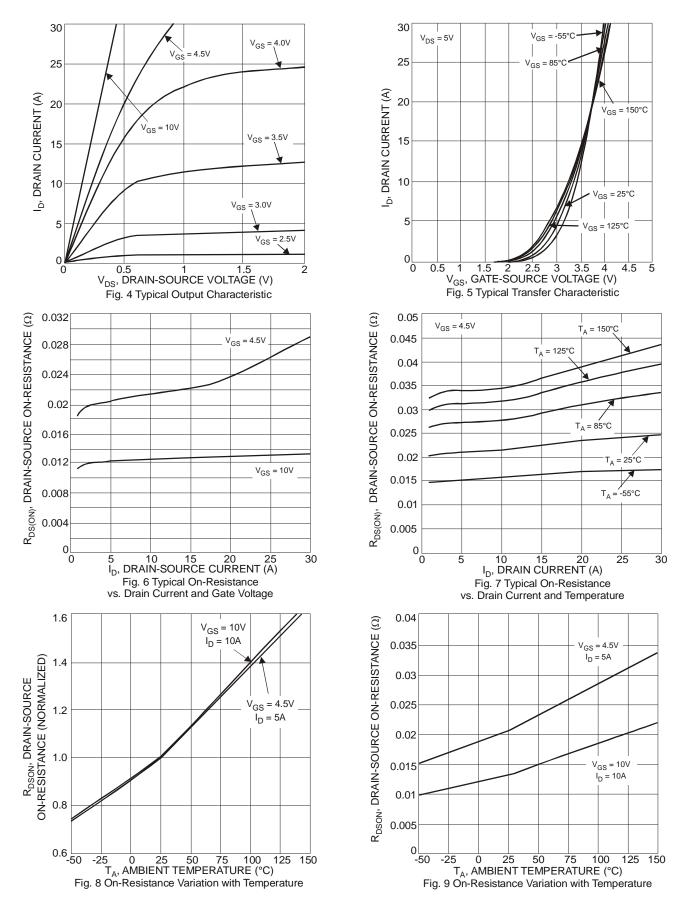
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	-	-	0.1	μΑ	$V_{DS} = 30V$ , $V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)	_	_			_		
Gate Threshold Voltage	$V_{GS(th)}$	0.9	1.2	1.8	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	В	-	13,5	18.6	$m\Omega$	$V_{GS} = 10V, I_D = 10A$	
Static Dialif-Source Off-Resistance	R <sub>DS (ON)</sub>	-	22	26.5		$V_{GS} = 4.5V, I_D = 7.5A$	
Forward Transfer Admittance	Y <sub>fs</sub>	-	13.0	-	S	$V_{DS} = 5V, I_{D} = 10A$	
Diode Forward Voltage	$V_{SD}$	-	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C <sub>iss</sub>	-	580	-		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	-	110	-	pF		
Reverse Transfer Capacitance	Crss	-	70	-		1 = 1.001112	
Gate Resistance	Rg	-	2.0	3.0	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge V <sub>GS</sub> = 4.5V	Qg	-	5.3	-		$V_{GS} = 4.5V, V_{DS} = 15V, I_D = 10A$	
Total Gate Charge V <sub>GS</sub> = 10V	Qg	-	11.3	-	nC		
Gate-Source Charge	$Q_{gs}$	-	1.9	-	IIC	$V_{GS} = 10V, V_{DS} = 15V,$ $I_{D} = 10A$	
Gate-Drain Charge	Q <sub>gd</sub>	-	1.9	-		ID = TOA	
Turn-On Delay Time	t <sub>D(on)</sub>	-	4.4	-	ns		
Turn-On Rise Time	t <sub>r</sub>	-	4.6	-	ns	$V_{GS} = 10V, V_{DS} = 15V,$	
Turn-Off Delay Time	t <sub>D(off)</sub>	-	19.5	-	ns	$R_L = 15\Omega$ , $R_G = 6\Omega$	
Turn-Off Fall Time	t <sub>f</sub>	-	5.8	-	ns		

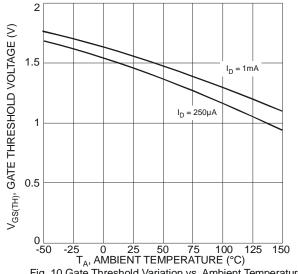
Notes:

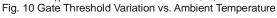
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to production testing.

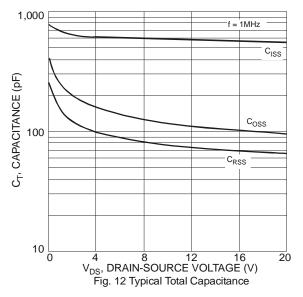


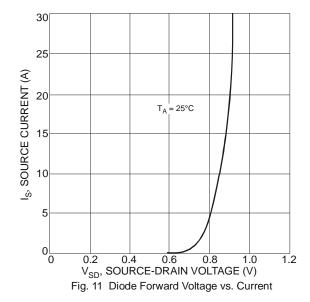


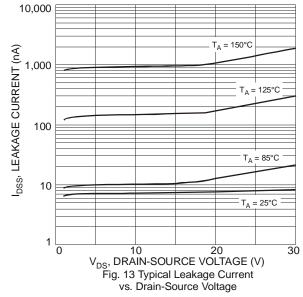








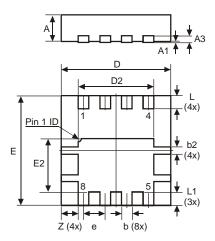






# **Package Outline Dimensions**

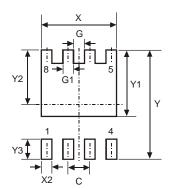
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI3333-8					
Dim	Min	Max	Тур		
D	3.25	3.35	3.30		
E	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E2	1.56	1.66	1.61		
Α	0.75	0.85	0.80		
A1	0	0.05	0.02		
A3	-	-	0.203		
b	0.27	0.37	0.32		
b2	_	_	0.20		
L	0.35	0.45	0.40		
L1	_	_	0.39		
е	_	_	0.65		
Z	_	_	0.515		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.650		
G	0.230		
G1	0.420		
Y	3.700		
Y1	2.250		
Y2	1.850		
Y3	0.700		
Х	2.370		
¥2	0.420		



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